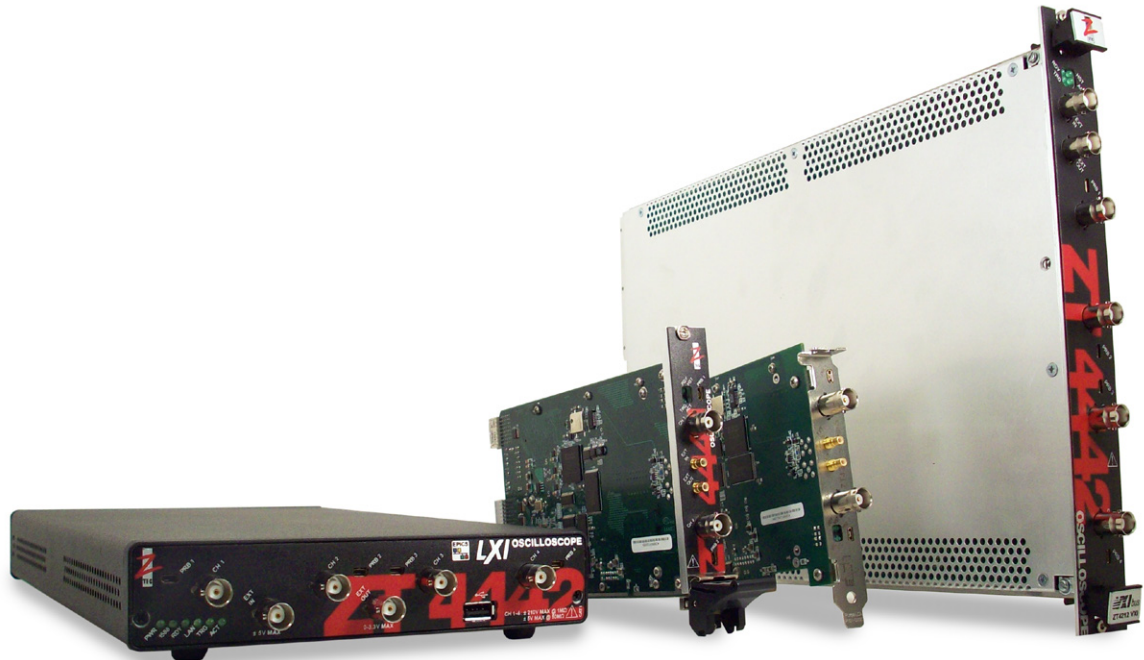


# ZT4440 Series Specifications



Digital Storage Oscilloscope  
14-bit, 800 MS/s, 300 MHz, 2 or 4 Channels  
PCI, PXI, VXI, or LXI

**M - Class**



Specifications are subject to change without notice. For the most recent specifications, download your product's manual at [www.ztecinstruments.com/support](http://www.ztecinstruments.com/support).



Technical support is available from the ZTEC Support Center at [www.ztecinstruments.com/support](http://www.ztecinstruments.com/support).



Browse our knowledgebase of programming examples & answers to frequently asked questions at [www.ztecinstruments.com/support/kb](http://www.ztecinstruments.com/support/kb).

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# Terminology

## Numeric Prefixes

When referring to large numeric values this manual will use SI (International System of Units) and IEC (International Electrotechnical Commission) standard prefixes.

Prefix	Multiplier
n (nano)	1/(1000x1000x1000)
μ (micro)	1/(1000x1000)
m (milli)	1/1000
k (kilo)	1000
M (Mega)	1000x1000
G (Giga)	1000x1000x1000
Ki (Kibi)	1024
Mi (Mebi)	1024x1024
Gi (Gibi)	1024x1024x1024

# Acquisition

## Sampling Modes

Normal: single-shot acquisition  
Average: multiple-capture averaging  
Envelope: multiple-capture minimum & maximum detection  
Equivalent time: multiple-capture high-rate reconstruction  
Peak detect: single-shot 10X over-sampling envelope detection  
High resolution: single-shot 10X over-sampling averaging  
Fast: multiple acquisitions

## Multiple-Capture Count

2 to 65536 waveforms in powers of 2

## Segmented Memory

View & compare history of previous waveforms in memory  
View component waveforms in memory when averaging

Sample Rate

20 kS/s to 400 MS/s, non-interleaved real-time  
 800 MS/s, interleaved real-time or equivalent-time  
 800 MS/s to 40 GS/s, equivalent-time  
 80 GS/s, interleaved equivalent-time

Any sample rate that is an integer multiple of an available sample rates can be created using interpolation.

Mode	Sample Rate
Non-Interleaved Real-Time	20 kS/s
	25 kS/s
	40 kS/s
	50 kS/s
	100 kS/s
	200 kS/s
	250 kS/s
	400 kS/s
	500 kS/s
	1 MS/s
	2 MS/s
	2.5 MS/s
	4 MS/s
	5 MS/s
	10 MS/s
	20 MS/s
	25 MS/s
	40 MS/s
	50 MS/s
	100 MS/s
200 MS/s	
400 MS/s	
Interleaved or Equivalent Time	800 MS/s
Equivalent Time	1.6 GS/s
	2.4 GS/s
	4 GS/s
	8 GS/s
	16 GS/s
	20 GS/s
40 GS/s	
Interleaved Equivalent Time	80 GS/s

Non-Interleaved Acquisition

2-channels @ up to 400 MS/s real-time (ZT4441)  
 4-channels @ up to 400 MS/s real-time (ZT4442)

Interleaved Acquisition

1-channel @ 800 MS/s real-time (ZT4441)  
 2-channels @ 800 MS/s real-time (ZT4442)

Acquisition Re-Arm Time

≤ 5 μs

## Total Memory Options

Product Option	Total Memory
ZT4441	256 MiSamples
ZT4442	512 MiSamples

## Maximum Record Length

Non-Interleaved	Interleaved
128 MiSamples	256 MiSamples

## Waveform Size

Acquisition Mode	Minimum Waveform Size	Maximum Waveform Size
Normal or Fast	10 Samples	Maximum Record Length (see above)
All other modes	10 Samples	512 KiSamples

## Maximum Segments

32 Ki waveforms @  $\leq 4$  KiSamples

# Vertical

## Number of Channels

ZT4441: Quantity 1 (interleaved acquisition)  
ZT4441: Quantity 2 (non-interleaved acquisition)  
ZT4442: Quantity 2 (interleaved acquisition)  
ZT4442: Quantity 4 (non-interleaved acquisition)

## Connectors

BNC

## Impedance

1 M $\Omega$  || 12 pF or 50  $\Omega$

## Impedance Accuracy

$\pm 1\%$

## Input Bias

$\leq \pm 10 \mu\text{A}$  (50  $\Omega$ )  
 $\leq \pm 1 \text{ nA}$  (1 M $\Omega$ )

## Coupling

DC or AC

## AC Coupling

200 kHz high-pass (50 $\Omega$ )  
10 Hz high-pass (1 M $\Omega$ )

## Analog Filter

20 MHz or Bypass  
Filter Stopband Rejection: approximately 3dB @ 20 MHz

## Probe Attenuation

0.9 to 1000:1

## Maximum Input (50 $\Omega$ )

$\pm 5 \text{ V}$  (DC + peak AC), CAT I

## Input load protection @ $\pm 6 \text{ VDC}$

## Maximum Input (1 M $\Omega$ )

$\pm 210 \text{ V}$  [DC + peak AC (<100 kHz)], CAT I  
Peak AC, de-rated 20 dB/decade above 100 kHz

Full Scale Input Range & Offset Adjust<sup>123</sup>

Impedance	Range	Full Scale	Offset	Maximum Range + Offset
1 M $\Omega$	5 V/div	50 Vpp	0V	$\pm 25V$
	2.5 V/div	25 Vpp	$\pm 12.5V$	$\pm 25V$
	1 V/div	10 Vpp	$\pm 10V$	$\pm 15V$
	500 mV/div	5 Vpp	$\pm 10V$	$\pm 12.5V$
	200 mV/div	2 Vpp	$\pm 2V$	$\pm 3V$
	100 mV/div	1 Vpp	$\pm 2V$	$\pm 2.5V$
	40 mV/div	400 mVpp	$\pm 400mV$	$\pm 600mV$
	20 mV/div	200 mVpp	$\pm 400mV$	$\pm 500mV$
	10 mV/div	100 mVpp	$\pm 400mV$	$\pm 450mV$
	5 mV/div	50 mVpp	$\pm 400mV$	$\pm 425mV$
2.5 mV/div	25 mVpp	$\pm 400mV$	$\pm 412.5mV$	
1.25 mV/div	12.5 mVpp	$\pm 400mV$	$\pm 406.25mV$	
50 $\Omega$	1 V/div	10 Vpp	0V	$\pm 5V$
	500 mV/div	5 Vpp	$\pm 2.5V$	$\pm 5V$
	200 mV/div	2 Vpp	$\pm 2V$	$\pm 3V$
	100 mV/div	1 Vpp	$\pm 2V$	$\pm 2.5V$
	40 mV/div	400 mVpp	$\pm 400mV$	$\pm 600mV$
	20 mV/div	200 mVpp	$\pm 400mV$	$\pm 500mV$
	8 mV/div	80 mVpp	$\pm 80mV$	$\pm 120mV$
	4 mV/div	40 mVpp	$\pm 80mV$	$\pm 100mV$
	2 mV/div	20 mVpp	$\pm 80mV$	$\pm 90mV$
1 mV/div	10 mVpp	$\pm 80mV$	$\pm 85mV$	

Analog Bandwidth

DC to 300 MHz typical, 250 MHz minimum

Due to an impedance mismatch between the signal generator and the oscilloscope, passing this test with a 200 MHz signal verifies 250 MHz performance on the 1 M $\Omega$  path.

Analog Bandwidth, Probe ZT6103 Passive X10<sup>4</sup>

DC to 300 MHz typical, 250 MHz minimum

Rise time<sup>5</sup>

1.15 ns

Slew Rate

2,000 V/ $\mu$ s

DC Gain Accuracy

$< \pm 0.25\%$  full scale range

DC Offset Accuracy (+25 °C)

$< \pm(0.25\%$  full scale range + 0.5% offset + 1 mV) (50 $\Omega$ )  
 $< \pm(0.25\%$  full scale range + 0.5% offset + 5 mV) (1M $\Omega$ )

DC Offset Drift (per °C)

$< \pm(0.01\%$  full scale range)

Input VSWR (50  $\Omega$ )

$\leq 1.3:1$ , DC to 250 MHz

1 Full-scale range assumes 10 divisions for vertical axis

2 Magnification is used below 4 mV/div range for 50 $\Omega$ . Full-scale range for accuracy specifications is defined as 40 mV

3 Magnification is used below 20 mV/div range for 1M $\Omega$ . Full-scale range for accuracy specifications is defined as 200 mV

4 See ZTEC Probe Manual for detailed specifications on all probes.

5 Rise time is calculated from  $t_r = 0.35 / \text{bandwidth}$ .

Typical RMS Noise	$\leq (0.05 \text{ of full scale range} + 75 \mu\text{V})$	(50 $\Omega$ Full Bandwidth)
	$\leq (0.025\% \text{ of full scale range})$	(50 $\Omega$ + 20 MHz Filter)
	$\leq (0.05 \text{ of full scale range} + 1 \text{ mV})$	(1M $\Omega$ Full Bandwidth)
	$\leq (0.025\% \text{ of full scale range} + 500 \mu\text{V})$	(1M $\Omega$ + 20 MHz Filter)

Channel-to-Channel Isolation	DC to 100 MHz: $\geq 60 \text{ dB}$
	100 MHz to 250 MHz: $\geq 50 \text{ dB}$

Digitizer Resolution	14 bits (0.006% of full scale)
	Up to 32 bits with averaging

Dynamic Range (400 MS/s, 10.7MHz (typical))

50 $\Omega$ Input Range (Vpp)	Signal-to-Noise Ratio (SNR)	Total Harmonic Distortion (THD)	Signal-to-Noise + Distortion (SINAD)	Spurious Free Dynamic Range (SFDR)
10.0	61.2 dBc	-62.8 dBc	58.9 dBc	65.0 dBc
5.0	59.0 dBc	-64.3dBc	57.9 dBc	65.0 dBc
2.0	60.0 dBc	-62.8 dBc	58.2 dBc	65.0 dBc
1.0	58.2 dBc	-64.3 dBc	57.3 dBc	65.0 dBc
0.4	55.7 dBc	-64.1 dBc	55.1 dBc	65.0 dBc
0.2	50.5 dBc	-64.9 dBc	50.4 dBc	63.3 dBc
0.08	49.4 dBc	-63.9 dBc	49.3 dBc	55.5 dBc
0.04	43.5 dBc	-63.1 dBc	43.4 dBc	48.9 dBc

## Horizontal

Horizontal Position	Pre-Trigger: 0 to 100% of acquisition window
	Post-Trigger: 0 to 10,000*Gate Resolution

$\pm 1$  sample interval position accuracy

Channel-to-Channel Skew	Channels at same input settings
	Channels 1-to-2: $\leq 100 \text{ ps}$
	Channels 3-to-4: $\leq 100 \text{ ps}$ (ZT4442)
	Channels 1-to-3, 1-to-4, 2-to-3, 2-to-4: $\leq 200 \text{ ps}$ (ZT4442)

Timebase Reference	10 MHz
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Timebase Reference Source	Internal TCXO, External Input, Backplane (PXI, VXI), Timing Expansion Connector (PCI)
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Internal TCXO Timebase	$\pm 2.5 \text{ ppm accuracy}$
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Timebase Output	External Output, Timing Expansion Connector Reference I/O (PCI)
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Sweep Time Range <sup>6</sup>	Minimum: 1.25 ns/div (12.5 ns total)
	Maximum: 10 s/div (100 seconds total)

Sweep Time Resolution	10ns to 10ms dependent on sweep points and sample rate
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<sup>6</sup> Horizontal time range assumes 10 divisions for horizontal axis

Skew Adjust	±10 µs channel-to-channel skew adjustment 1 sample interval resolution ±1 sample interval accuracy
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## Trigger

Sweep Modes	Auto or normal triggered
Trigger Source	Channels 1 to 2, Channels 3 to 4 (ZT4442), External Input, Pattern, Software, TTL Trigger 0-7, Star Trigger (PXI/PCI), ECL Trigger 0-1 (VXI)
Trigger Slope/Polarity	Positive or Negative
Trigger B	Qualify trigger on second source for edge trigger event
Trigger A Holdoff	Programmable delay after trigger A before recognizing next trigger A event
Trigger B Holdoff	Programmable delay after trigger A before recognizing trigger B event
Trigger A or B Holdoff Range	0 to 100 seconds
Trigger A or B Event Counter	Qualify trigger on N <sup>th</sup> trigger event, N = 1 to 65536
Trigger A Modes	Edge, Pattern, State, Pulse Width, Video
Trigger B Modes	Edge, Pattern
Edge Trigger Mode	Rising or falling edge
Pattern Trigger Mode	Pattern match true or false
Pattern Sources	Channels 1 to 2, Channels 3 to 4 (ZT4442), External Input, Pattern, Software, TTL Trigger 0-7, Star Trigger (PXI/PCI), ECL Trigger 0-1 (VXI)
State Trigger Mode	Edge event when pattern match true or false Pattern source used as Arm qualifier
Pulse Width Trigger Mode	Triggers on pulse width greater than, less than, within limits, or outside limits
Pulse Width Type	< limit1, > limit1, < limit1 & > limit2, > limit1 & < limit2
Pulse Width Limits	10 ns to 500 ms, 5ns resolution, ±5ns accuracy
Pulse Width Minimum	2 ns pulse width captured for < limit1
Video Trigger Mode	PAL (50 Hz), NTSC (60 Hz), SECAM (50 Hz) Standard, Field, Line selectable
Trigger Timestamp	100 ns resolution, 1 second rollover

## Trigger, Analog Input

Analog Input Triggers	Channels 1 & 2, Channels 3 & 4 (ZT4442)
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Trigger Level	(offset – full scale range/2) to (offset + full scale range/2)
Trigger Hysteresis	2.5% (overdrive required)
Trigger Level Resolution	0.025% of full scale range
Trigger Level Accuracy	±(2% full scale range + 5mV + offset accuracy)
Trigger Sensitivity	5% of full scale range (DC to 100 MHz) 10% of full scale range (> 100 MHz)
Trigger Bandwidth	DC to 300 MHz typical, 250 MHz minimum
Glitch Detection	≥ 500 ps glitch captured in edge trigger mode

## External Input

Functionality	External Trigger, External 10 MHz Timebase Reference, or External Arm
Maximum Input	±5 V (DC + peak AC), CAT I
Threshold Adjustment	±2V
Threshold Accuracy	±20 mV
Threshold Resolution	0.5 mV
Input Impedance	1 MΩ    30 pF or 50 Ω
Impedance Accuracy	± 2%
Input Bandwidth	300 MHz typical 250 MHz minimum
Input Hysteresis	20 mV (overdrive required)
Connector	BNC (VXI, LXI) SMB (PCI, PXI)

## External Output

Functionality	Trigger Output, 10 MHz Timebase Reference Output, Event Output, Programmable Clock Output, Programmable Pulse Output, Limit Test Successful, and 10 kHz Probe Compensation Output
Output Level	TTL Compatible into High Impedance (≥ 200 Ω) ± 24 mA Output Drive Capability
Output Enable	Tri-State Output Capability
Output Source	Arm Event, Trigger A Event, Trigger B Event, Trigger Complete Event, Capture Complete Event, Operation Complete Event, Master Summary Status event, Constant Level, Reference Clock, Programmable Clock, Programmable Pulse, Limit Test Successful Event, Probe Compensation
Output Event Pulse	Programmable from 50 ns to 0.163 seconds

Programmable Clock	Clock Period: 26.667 ns to 100 seconds 50% Duty Cycle
Programmable Pulse	Pulse Repetition Interval: 26.667 ns to 100 seconds Pulse Width: 26.667 ns
Probe Compensation	10kHz Clock which can be used to compensate probes
Limit Test Successful	1 $\mu$ s pulse after each capture upon limit or mask test success
Connector	BNC (VXI, LXI) SMB (PCI, PXI)

## Event Outputs

Functionality	Event Output Signals
Outputs	TTL Trigger 0-7, ECL Trigger 0-1 (VXI) Timing Expansion Connector (PCI)
Source	Arm Event, Trigger A Event, Trigger B Event, Trigger Complete, Capture Complete, Operation Complete, Master Summary Status, Constant Level
Output Event Pulse	Programmable from 50 ns to 0.163 seconds

## Arm

Functionality	Arm to qualify trigger event
Source	External Input, TTL Trigger 0-7, Star Trigger (PXI/PCI), ECL Trigger 0-1 (VXI), Software
Polarity	Positive or Negative

## Measurements

Measurements	AC RMS, Amplitude, Average, Cycle Average, Cycle Frequency, Cycle Period, Cycle RMS, DC RMS, Duty Cycle High, Duty Cycle Low, ENOB, Number of Falling Edges, Fall Crossing Time, Fall Overshoot, Fall Preshoot, Fall Time, Frequency, High, Low, Maximum, Mid, Minimum, Peak-to-Peak, Period, Phase, Pulse Width Positive, Pulse Width Negative, Number of Rising Edges, Rise Crossing Time, Rise Overshoot, Rise Preshoot, Rise Time, SFDR, SINAD, SNR, Standard Deviation, THD, Time of Maximum, Time of Minimum
Edge Measurements	Nth edge selectable, N = 1 to 65535
Maximum Measurements	Nth maximum selectable, N = 1 to 100, Applies to Maximum and Time of Maximum measurements
Measurement Methods	Entire Waveform, Gated by Time, Gated by Points, Gated by Frequency, Gated by Cursors
Measurement Levels	Low, Mid, High reference levels for edge measurements set in absolute voltages or relative percentages

Cursors	Quantity 2 Horizontal & Vertical Axis Location Markers X, Y, $\Delta X$ & $\Delta Y$ Measurements
Measurement Lists	Quantity 4 Lists Up to eight measurements that are performed upon acquisition Stored for rapid measurement setup
Measurement Trending	History buffer of past measurement data stored in Calculate channel (See Calculate section.)
Measurement Accuracy	Delta DC Voltage $\pm$ (DC gain accuracy) Absolute DC Voltage $\pm$ [(DC gain accuracy)+(offset accuracy)] Time $\pm$ (time resolution) Frequency $\pm$ [1/(time resolution)]
	Note: time resolution = one sample interval, one equivalent-time sample interval, or one interpolated-time sample interval (depending upon acquisition mode)

## Reference Waveforms

Reference Channels	Quantity 4
Reference Storage	Non-volatile memory storage
Reference Size	32 KiSample maximum waveform size

## Calculations

Calculate Channels	Quantity 4
Calculate Size	512 KiSample maximum waveform size
Calculate Data	32-bit resolution
Calculate Functions	Add, Subtract, Multiply, Copy, Invert, Integral, Derivative, Absolute Value, Limit Test, Mask Test, Frequency Transform, Time Transform, Histogram, Measurement Trending
Limit Test	Measurement Limit Range Testing or Waveform Mask Testing
Limit Test Reporting	Measurement maximum, minimum, average, current value, pass/fail counts
Frequency Transform	FFT Magnitude
FFT Windowing	Rectangular, Hamming, Hanning, Blackman, Flattop
FFT Data Format	Linear Magnitude, Logarithmic Magnitude, Phase, Real, Imaginary
Time Transform	Digital Infinite Impulse Response (IIR) filter
IIR Filter Type	Auto-generate: low-pass, 2 to 40 data point smoothing
Histogram	65536 bins for up to 16-bit histogram horizontal resolution
Measurement Trending	Historical waveform of past measurement data

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Provides trend data of 1 measurement point per capture

## Data Processing & Download

Auto Scale	Automatic adjust to input signals: Input Range, Offset, Sample Rate, Trigger Source, and Trigger Level
Waveform Download Mode	Normal: every real-time data point Decimated: every Nth real-time point (N = 2 to 100,000) Interpolated: N points for every real-time point (N = 2 to 100), points interpolated by $\sin(x)/x$ reconstruction
Self-Calibration	Automatic internal calibration: Input DC Offset Zero, Input DC Offset Adjust Scale Factor
Waveform Data Formats	16-bit or 32-bit signed integer 32-bit or 64-bit floating point, Intel or Motorola Byte Order

## Instrument Setup Storage

Reset	Non-volatile storage of default instrument setup configuration
Save & Recall	Non-volatile storage of 30 instrument setup configurations

## PCI/PXI Data Interface

PCI Bus	33 MHz, 32 bit
PCI Data Transfer Rate	132 MByte/s burst up to 120 MByte/s sustained <sup>7</sup>
PCI Voltage	Universal, +3.3V or +5V
PCI Compatibility	Version 2.2
PXI Compatibility	PXI Standard Slot and PXI Express Hybrid Slot Compatible
PXI Signals (XJ4 connector)	PXI_TRIG0-7 input/output selectable PXI_STAR input 10 MHz reference input Left and right side buses not used
Primary ID	3712 (0E80 <sub>16</sub> )

## VXI Data Interface

Command Interface	A16 message-based servant, SCPI compatible
Interrupt Operation	Programmable interrupter, Level 1–7

<sup>7</sup> Sustained transfer rates are dependent upon host system configuration.

Manufacturer ID 3712 (0E80<sub>16</sub>)

## LXI Data Interface

Command Interface LAN 10/100,  
USB 2.0 Full-Speed 12 MB/s,  
SCPI compatible

Manufacturer ID 3712 (0E80<sub>16</sub>)

## PXI XJ4 Trigger & Clock Pin Usage

Pin A5	PXI Trigger 3	(TTL level bi-directional)
Pin A6	PXI Trigger 2	(TTL level bi-directional)
Pin A7	PXI Trigger 1	(TTL level bi-directional)
Pin B5	PXI Trigger 4	(TTL level bi-directional)
Pin B7	PXI Trigger 0	(TTL level bi-directional)
Pin C5	PXI Trigger 5	(TTL level bi-directional)
Pin D6	PXI Star Trigger	(TTL level input)
Pin E5	PXI Trigger 6	(TTL level bi-directional)
Pin E6	PXI CLK10	(TTL level input)
Pin E7	PXI Trigger 7	(TTL level bi-directional)

## PCI Timing Expansion Connector Pin Usage

Pin 1	Reference	(TTL level bi-directional)
Pin 3	Star Trigger	(TTL level bi-directional)
Pin 5	Trigger 7	(TTL level bi-directional)
Pin 7	Trigger 6	(TTL level bi-directional)
Pin 9	Trigger 5	(TTL level bi-directional)
Pin 11	Trigger 4	(TTL level bi-directional)
Pin 13	Trigger 3	(TTL level bi-directional)
Pin 15	Trigger 2	(TTL level bi-directional)
Pin 17	Trigger 1	(TTL level bi-directional)
Pin 19	Trigger 0	(TTL level bi-directional)

## VXIbus P2 Trigger & Clock Pin Usage

Pin A1	ECLTRG0	(ECL level bi-directional)
Pin A3	ECLTRG1	(ECL level bi-directional)
Pin A23	TTLTRG0*	(TTL level bi-directional)
Pin A24	TTLTRG2*	(TTL level bi-directional)
Pin A26	TTLTRG4*	(TTL level bi-directional)
Pin A27	TTLTRG6*	(TTL level bi-directional)
Pin C1	CLK10+	(ECL level input)
Pin C2	CLK10-	(ECL level input)
Pin C23	TTLTRG1*	(TTL level bi-directional)
Pin C24	TTLTRG3*	(TTL level bi-directional)
Pin C26	TTLTRG5*	(TTL level bi-directional)

## LED Indicators

Ready(RDY)	<p>OFF: Hardware failure</p> <p>ON: Unit has passed power-up self-diagnostics</p> <p>TOGGLE: unit has an error pending in error queue</p>
Host(HST/LAN)	<p>OFF: Interface fault</p> <p>ON: Normal interface operation</p> <p>TOGGLE: device identify command received</p>
Trigger(TRG)	<p>OFF: trigger event not detected</p> <p>ON/PULSE: trigger complete event detected</p>
Active(ACT)	<p>OFF: Instrument Idle</p> <p>ON/PULSE: Data acquisition initiated</p>
1588 Clock Status (LXI only)	<p>OFF: IEEE 1588 clock not synchronized or fault</p> <p>ON: clock locked as IEEE 1588 slave</p> <p>TOGGLE @ 1s: clock synchronized as IEEE 1588 master</p> <p>TOGGLE @ 2s: clock synchronized as IEEE 1588 grand master</p>
Power (PWR, LXI only)	<p>ON: Instrument is powered on</p> <p>OFF: Instrument is powered off</p>

## Status Reporting

IEEE-488.2 Device Status	Reporting Structure including Status Byte, Standard Event Registers, Questionable Registers, Operation Registers
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## Identification

Secondary ID	<p>PCI/PXI: 4400 (1130<sub>16</sub>)</p> <p>VXI/LXI: 440 (1B8<sub>16</sub>)</p>
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# Power

## Power Supplies

Product Option	Platform	Voltage	Typical Current	Maximum Current
ZT4441	PCI or PXI	+3.3 VDC	3.37A	4.19A
		+5 VDC	1.23A	1.80A
		+12 VDC	0.02A	0.02A
		-12 VDC	0.01A	0.01A
	VXI	+5 VDC	3.96A	5.33A
		+12 VDC	0.02A	0.02A
		+24 VDC	0.00A	0.00A
		-2 VDC	0.07A	0.08A
		-5.2 VDC	0.32A	0.36A
		-12 VDC	0.01A	0.01A
LXI	115 VAC	0.29A	0.32A	
ZT4442	VXI	+5 VDC	6.47A	8.50A
		+12 VDC	0.05A	0.05A
		+24 VDC	0.00A	0.00A
		-2 VDC	0.07A	0.08A
		-5.2 VDC	0.49A	0.57A
		-12 VDC	0.02A	0.02A
		-24 VDC	0.00A	0.00A
	LXI	115 VAC	0.41A	0.47A

## Total Cooling & Power Consumption

Product Option	Platform	Typical Cooling & Power	Maximum Cooling & Power
ZT4441	PCI or PXI	17.6W	23.2W
	VXI	21.9W	29.0W
	LXI	33.6W	36.9W
ZT4442	VXI	35.7W	46.3W
	LXI	47.2W	53.9W

## AC Power (LXI)

Line Voltage	90-264 VAC, 47-63 Hz, automatic selection
Input Protection	AC line fuse, 250 VAC, 2.0 A, fast-acting
Harmonic Distortion	Meets EN61000-3-2
Surge Withstand	Meets EN61000-4
EMI Filtering	Meets CISPR 11 and 22 and FCC Part 15 Class B (conducted)

# Physical

PCI Physical size	Single-Slot Short PCI Card 7.65" x 0.85" x 4.97" (LxWxH) 19.43 cm x 2.16 cm x 12.62 cm (LxWxH)
PXI Physical size	Single-Wide 3U Compact PCI/PXI Instrument 8.25" x 0.79" x 5.25" (LxWxH) 22.23 cm x 2.01 cm x 13.34 cm (LxWxH)
VXI Physical size	Single-Wide C-size VXIbus Instrument 14.45" x 1.20" x 10.35" (LxWxH) 36.70 cm x 3.05 cm x 26.29 cm (LxWxH)
LXI Physical size	Half-Width 1U LXI Instrument 13.35" x 7.25" x 1.75" (LxWxH) 33.91 cm x 18.42 cm x 4.45 cm (LxWxH)
PCI Weight	12.3 oz or 349 g
PXI Weight	12.3 oz or 349 g
VXI Weight	2.82 lbs or 1.28 kg (ZT4441) 3.11 lbs or 1.41 kg (ZT4442)
LXI Weight	4.48 lbs or 2.03 kg (ZT4441) 4.77 lbs or 2.16 kg (ZT4442)

## Operating and Storage Conditions

### Temperature Range

Operating	0 °C to +50 °C Ambient
Storage	-40 °C to +75 °C
Over-Temperature	Automatic shutdown if internal temperature exceeds +70 °C
Calibration Range	+20 °C to +30 °C Ambient, after a 20 minute warm-up period, to meet all calibration specification accuracies.

### Relative Humidity

Operating or Storage	10 to 90%, non-condensing, up to +40 °C
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### Altitude

Operating	Up to 3,000 m Up to 5,000 m with Maximum Input (1 M $\Omega$ ) of $\pm 100$ V
Storage	Up to 15,000 m

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# Safety

This product is designed to meet the requirements of the following standard of safety for electrical equipment for measurement, control and laboratory use:

EN 61010-1

# Electromagnetic Compatibility

CE Marking EN 61326-1:1997 with A1:1998 and A2:2001 Compliant

FCC Part 15 (Class A) Compliant

## Emissions

EN 55011	Radiated Emissions, ISM Group 1, Class A, distance 10 m, emissions < 1 GHz
EN 55011	Conducted Emissions, Class A, emissions < 30 MHz Immunity
EN 61000-4-2	Electrostatic Discharge (ESD), 4 kV by Contact, 8 kV by Air
EN 61000-4-3	RF Radiated Susceptibility, 10 V/m
EN 61000-4-4	Electrical Fast Transient Burst (EFTB), 2 kV AC Power Lines
EN 61000-4-5	Surge
EN 61000-4-6	Conducted Immunity
EN 61000-4-8	Power Frequency Magnetic Field, 30 A/m
EN 61000-4-11	Voltage Dips and Interrupts

# CE Compliance

This product meets the necessary requirements of applicable European Directives for CE Marking as follows:

73/23/EEC	Low Voltage Directive (Safety)
89/336/EEC	Electromagnetic Compatibility Directive (EMC)

See Declaration of Conformity for this product for additional regulatory compliance information.

# LXI Conformance

This product's LXI models are conformant to the LXI Consortium's Functional Class C, Revision 1.2